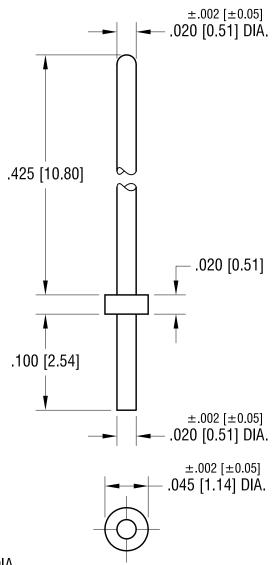
THIS DOCUMENT IS THE PROPERTY OF KEYSTONE ELECTRONICS CORP. AND SHALL NOT BE REPRODUCED, DISTRIBUTED OR USED AS A BASIS FOR MANUFACTURE WITHOUT PRIOR WRITTEN PERMISSION FROM KEYSTONE ELECTRONICS CORP.



REV.

NOTE: 1. MOUNTING HOLE .021 [0.61] DIA.

DESCRIPTION

DATE

KEYSTONE ELECTRONICS CORP.	
www.keyelco.com • NEW HYDE PARK, NY 11040 • Tel (516) 328-7500	
PART NAME	
MICRO PIN, SOLDER MOUNT	
MATERIAL	
BRASS	
GOLD PLATE	BOONE DATE 11.04.96
GOLD PLATE	APP'D RH SCALE 10X
TOLERANCES INCH [MM] CODE	DWG NO.
DECIMAL ± .005 [± 0.13] ANGULAR ± 1° UNLESS OTHERWISE SPECIFIED	1999-3